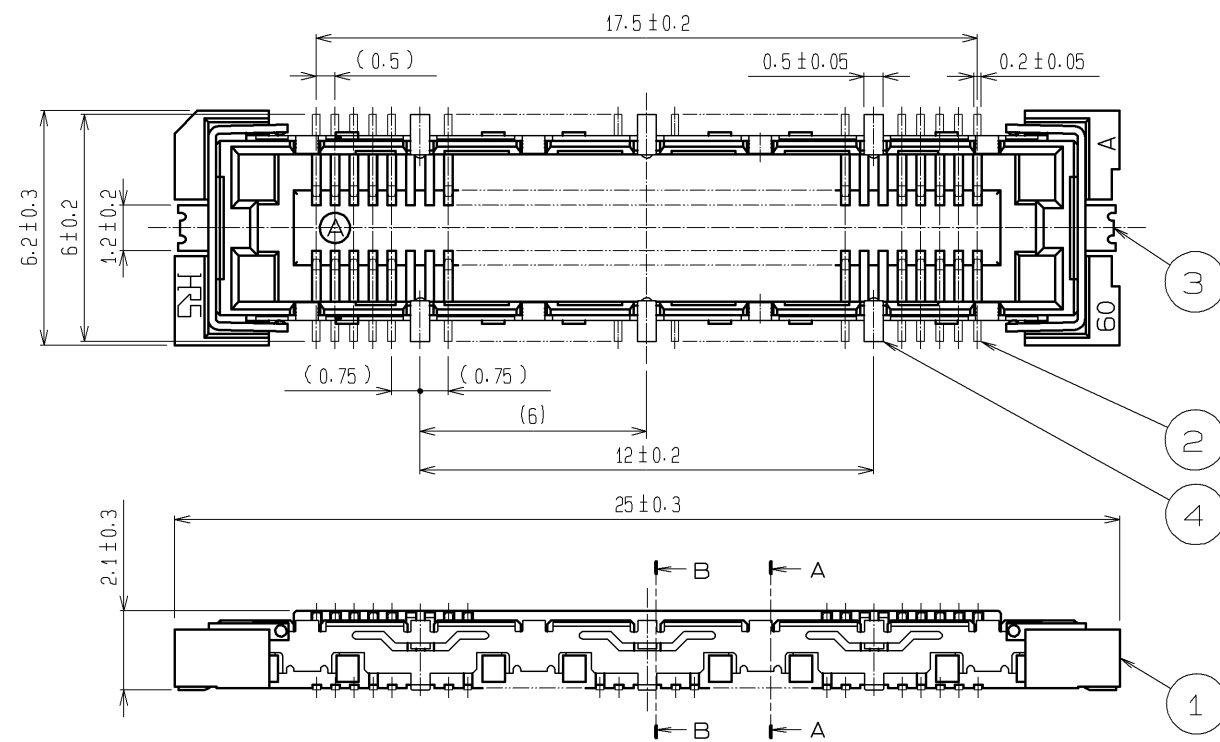
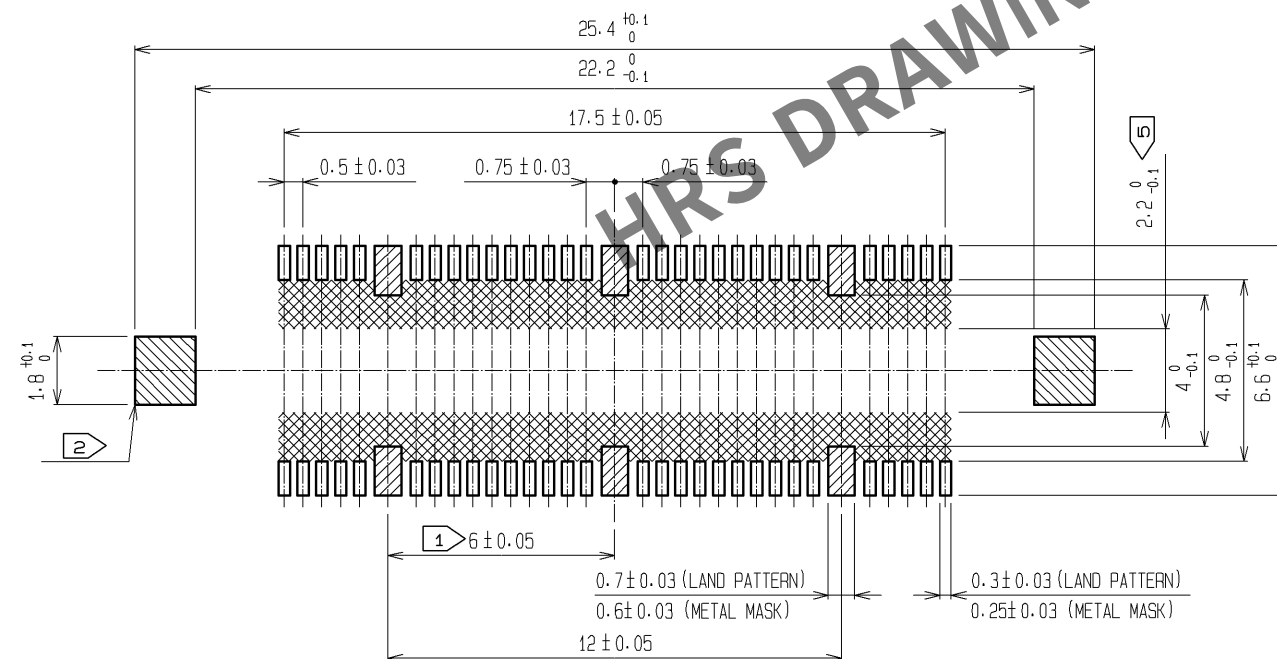
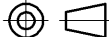




RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



- NOTES
- ① 6 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND .OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

3. 4		PHOSPHOR BRONZE	TIN PLATING	2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.					
1		LCP	BEIGE UL94V-0			LEAD AREA : GOLD 0.05μm min.					
						UNDER PLATING : NICKEL 1μm min.					
NO.		MATERIAL		FINISH , REMARKS		NO.	MATERIAL		FINISH , REMARKS		
UNITS mm				SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		12.03.08		DRAWING NO.		EDC3-152636-25			
		CHECED : HT. YAMAGUCHI		12.03.08		PART NO.		FX11B-60S/6-SV(71)			
		DESIGNED : TS. MIYAKI		12.03.08		CODE NO.		CL573-0712-2-71			
		DRAWN : TS. MIYAKI		12.03.08				 1/1			